

APPROVAL SHEET

RGCMF Series – 1210(0504)- RoHS Compliance

MULTILAYER CERAMIC COMMON MODE FILTER

Halogens Free Product

P/N: RGCMF1210900H3T

*Contents in this sheet are subject to change without prior notice.

FEATURES

- 1. Miniature footprint: 1.25 X 1.00 X 0.80 mm³
- 2. Multilayer LTCC (Low Temperature Ceramic Cofired) Technology
- 3. Reflow solderable SMD Devices
- 4. Wide Pass Band (Cut-Off Frequency: -3dB@ 4GHz Typical)
- 5. High Attenuation for common mode noise
- 6. Special 3D layout design to minimize phase shifting

APPLICATIONS

- 1. EMI suppression on HDMI/ (mini)LVDS/ DVI/ SATA/ PCI-E/ Display Port high speed data transmission
- 2. PC related, LCD TV, PDP TV, Projector, STB, Blue-ray DVD, panel.

CONSTRUCTION





Fig 1. Outline of 1210 size Common Mode Filter and Schematics

DIMENSIONS

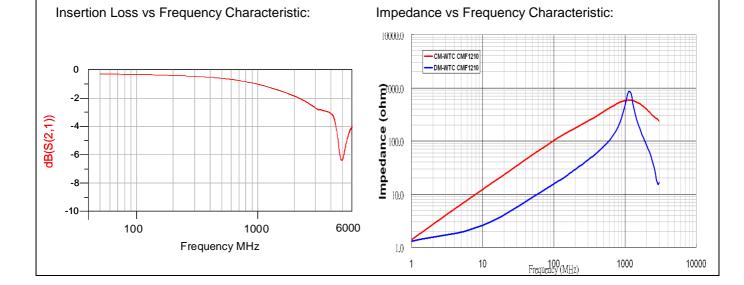
Figure	Symbol	Dimension
	L	1.25 ± 0.10mm
	W	1.00 ± 0.10mm
	Т	0.80 ± 0.10mm
	А	0.55 ± 0.10mm
	В	0.20 ± 0.15mm
В	С	0.30 ± 0.10mm



ELECTRICAL CHARACTERISTICS

RGCMF1210900H3T	Specification		
Cut-off Frequency	4 GHz (Typical)		
Common Mode Impedance	90 ohm ± 20% @ 100MHz		
DC Resistance	Max. 1.0 Ω		
Rated Current	300 mA		
Characteristic Impedance (Differential)	100 Ω(Typical)		
Operating Temperature	- 40 °C ~ +85 °C		

Typical Electrical Chart



SOLDER LAND PATTERN

Figure	Symbol	Dimension (mm)
LI -	L1	1.75 ± 0.05
	L2	0.30 ± 0.10
	L3	0.75 ± 0.05
L3	L4	0.55 ± 0.05

Line width to be designed to match 50 $\,\Omega$ characteristic impedance, depending on PCB material and thickness.



RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6	*Solder bath temperature : 235 ± 5°C	At least 95% of a surface of each terminal
JESD22-B102D	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
	*Solder : Sn3Ag0.5Cu for lead-free	
Leaching (Resistance to dissolution of metallization)	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : $30 \pm 0.5 \text{ sec}$	Loss of metallization on the edges of each electrode shall not exceed 25%.
IEC 60068-2-58	*Solder : SN63A	
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature∶ 120~150°C,	No mechanical damage.
	1 minute.	Samples shall satisfy electrical specification
	*Solder temperature: 270±5°C	after test.
	*Immersion time: 10±1 sec	Loss of metallization on the edges of each
	*Solder : Sn3Ag0.5Cu for lead-free	electrode shall not exceed 25%.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface : Rigid surface of concrete	Samples shall satisfy electrical specification
	or steel.	after test.
	*Times : 6 surfaces for each units ; 2 times for each side.	
Adhesive Strength	*Pressurizing force :	No remarkable damage or removal of the
of Termination	5N(≦0603);10N(>0603)	termination.
JIS C 0051- 7.4.3	*Test time: 10±1 sec	
Bending test	The middle part of substrate shall be	No mechanical damage.
JIS C 0051- 7.4.1	pressurized by means of the pressurizing	Samples shall satisfy electrical specification
	rod at a rate of about 1 mm/s per second	after test.
	until the deflection becomes 1mm/s and	
	then pressure shall be maintained for 5±1	
	sec.	
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

Approval sheet		Walsin Technology Corporation
Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical
	3. 30±3 minutes at +85°C±3°C,	specification after test.
	4. 10~15 minutes at room temperature,	
	Total 100 continuous cycles	
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude : 1.5mm	Samples shall satisfy electrical specification
	*Test times: 6hrs.(Two hrs each in three	after test.
	mutually perpendicular directions)	
High temperature	*Temperature : 85°C±2°C	No mechanical damage.
JIS C 0021	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature : 40±2°C	Samples shall satisfy electrical specification
JIS C 0022	*Time: 1000+24/-0 hrs.	after test.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
	500hrs measuring the first data then	
	1000hrs data	
Low temperature JIS C 0020	*Temperature : -40°C±2°C	No mechanical damage.
313 C 0020	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
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SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

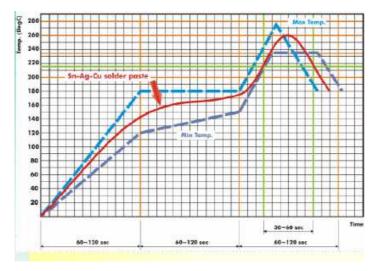


Fig 2. Infrared soldering profile

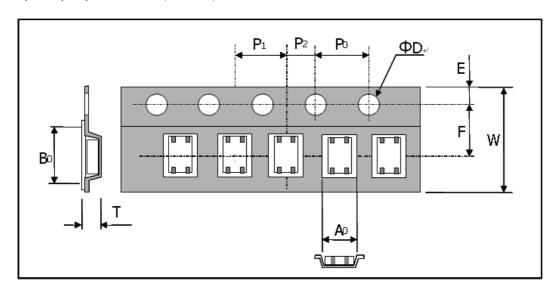
ORDERING CODE

RG	CMF	1210	900	Н	3	Т
Walsin	Product Code	Dimension code	CM Impedance	Application	Specification	Packing
RF device	CMF:	1210 =	900: 90 ohm	H: HDMI/ DVI/	Code from 0 ~ 9	T: Reeled
	Common Mode	Width 12,		LVDS/ SATA/ PCI-	dependent on	
	Filter	Length 10,		/ D-Port	different electrical	
		,			specification	

Minimum Ordering Quantity: 2000 pcs per reel.

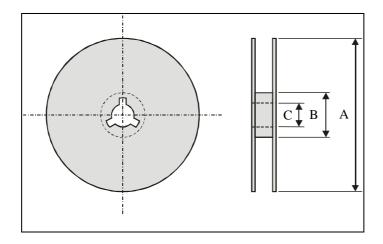
PACKAGING

Paper Tape specifications (unit :mm)



Index	A ₀	B ₀	ΦD	Т	W
Dimension(mm)	1.20±0.10	1.50±0.10	1.50±0.10	0.9±0.10	8.0±0.10
Index	Е	F	P ₀	P ₁	P_2
Dimension(mm)	1.75±0.10	3.5±0.05	4.0±0.10	4.0±0.10	2.0±0.05

Reel dimensions



Index	А	В	С
Dimension (mm)	Ф178.0	Φ60.0	Ф13.0

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

(1) Products in N_2 gas sealed bag should be used in 6 months from the day of WALSIN outgoing inspection and 1 month after open, which can be confirmed the quality.



- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40 $^{\circ}$ C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.